SDAS055E - APRIL 1982 - REVISED JULY 1996

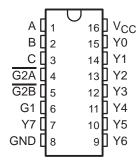
- **Designed Specifically for High-Speed Memory Decoders and Data Transmission Systems**
- **Incorporate Three Enable Inputs to Simplify** Cascading and/or Data Reception
- **Package Options Include Plastic** Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

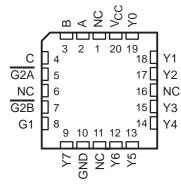
The 'ALS138A and 'AS138 are 3-line to 8-line decoders/demultiplexers designed for highperformance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance systems, these devices can be used to minimize the effects of decoding. When employed system high-speed memories with a fast enable circuit, the delay times of the decoder and the enable time of the memory are usually less than the typical access time of the memory. The effective system delay introduced by the Schottky-clamped system decoder is negligible.

The conditions at the binary-select (A, B, and C) inputs and the three enable (G1, $\overline{G2A}$, and $\overline{G2B}$) inputs select one of eight output lines. Two active-low and one active-high enable inputs

SN54ALS138A, SN54AS138 . . . J PACKAGE SN74ALS138A, SN74AS138...D OR N PACKAGE (TOP VIEW)



SN54ALS138A, SN54AS138 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented without external inverters and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications.

The SN54ALS138A and SN54AS138 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS138A and SN74AS138 are characterized for operation from 0°C to 70°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

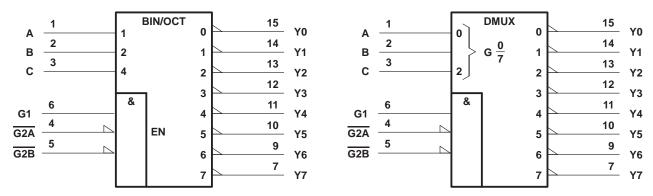


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FUNCTION TABLE

| | | INP | UTS | | | | | | OUT | PUTS | | | |
|----|---------------|-----|-----|---|---|----------|----|----|-----|------|----|----|----|
| | ENABLE SELECT | | | | | 0011 013 | | | | | | | |
| G1 | G2A | G2B | С | В | Α | Y0 | Y1 | Y2 | Y3 | Y4 | Y5 | Y6 | Y7 |
| Х | Н | Х | Х | Х | Х | Н | Н | Н | Н | Н | Н | Н | Н |
| Х | X | Н | Х | Χ | Χ | Н | Н | Н | Н | Н | Н | Н | Н |
| L | X | X | Х | Χ | Χ | Н | Н | Н | Н | Н | Н | Н | Н |
| Н | L | L | L | L | L | L | Н | Н | Н | Н | Н | Н | Н |
| Н | L | L | L | L | Н | Н | L | Н | Н | Н | Н | Н | Н |
| Н | L | L | L | Н | L | Н | Н | L | Н | Н | Н | Н | Н |
| Н | L | L | L | Н | Н | Н | Н | Н | L | Н | Н | Н | Н |
| Н | L | L | Н | L | L | Н | Н | Н | Н | L | Н | Н | Н |
| Н | L | L | Н | L | Н | Н | Н | Н | Н | Н | L | Н | Н |
| Н | L | L | Н | Н | L | Н | Н | Н | Н | Н | Н | L | Н |
| Н | L | L | Н | Н | Н | Н | Н | Н | Н | Н | Н | Н | L |

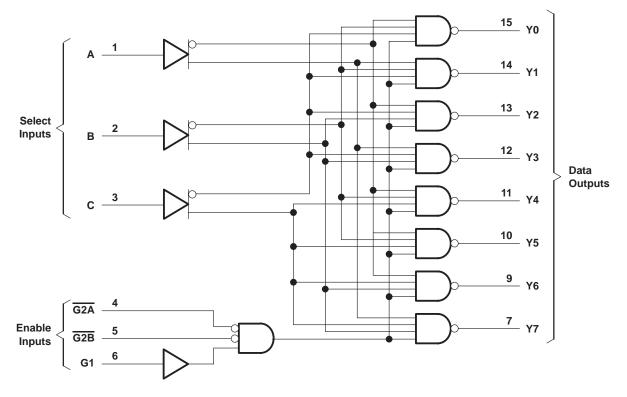
logic symbols (alternatives)†



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.



logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage, V _{CC} | 7 V |
|--|---------------|
| Input voltage, V _I | 7 V |
| Operating free-air temperature range, T _A : SN54ALS138A | 55°C to 125°C |
| SN74ALS138A | 0°C to 70°C |
| Storage temperature range, T _{stq} | 65°C to 150°C |

recommended operating conditions

| | | SN54ALS138A | | | SN7 | UNIT | | |
|-----|--------------------------------|-------------|-----|------|-----|------|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| VIL | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| loh | High-level output current | | | -0.4 | | | -0.4 | mA |
| lOL | Low-level output current | | | 4 | | | 8 | mA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST C | SN54ALS138A | | | SN74ALS138A | | | UNIT | |
|-----------------|---------------------------|----------------------------|------------------|------|-------------|--------------------|------|------|----|
| PARAMETER | TEST | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | UNIT | |
| VIK | V _{CC} = 4.5 V, | $I_{I} = -18 \text{ mA}$ | | | -1.5 | | | -1.5 | V |
| Voн | $V_{CC} = 4.5 \text{ V},$ | $I_{OH} = -0.4 \text{ mA}$ | VCC -2 | 2 | | V _{CC} -2 | 2 | | V |
| \/o. | V _{CC} = 4.5 V | I _{OL} = 4 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | V |
| VOL | VCC = 4.5 V | I _{OL} = 8 mA | | | | | 0.35 | 0.5 | V |
| lį | V _{CC} = 5.5 V, | V _I = 7 V | | | 0.1 | | | 0.1 | mA |
| lін | V _{CC} = 5.5 V, | V _I = 2.7 V | | | 20 | | | 20 | μΑ |
| I _{IL} | V _{CC} = 5.5 V, | V _I = 0.4 V | | | -0.1 | | | -0.1 | mA |
| ΙΟ§ | $V_{CC} = 5.5 \text{ V},$ | V _O = 2.25 V | -20 | | -112 | -30 | | -112 | mA |
| Icc | V _{CC} = 5.5 V | | | 5 | 10 | | 5 | 10 | mA |

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _C (C _L : R _L : T _A : | | UNIT | | |
|------------------|---------------------|----------------|--|-------|--------|-------|-----|
| | , , | , , , | SN54AL | S138A | SN74AL | S138A | |
| | | | MIN | MAX | MIN | MAX | |
| t _{PLH} | A, B, C | Any V | 2 | 28 | 5 | 22 | ns |
| t _{PHL} | А, Б, С | Any Y | 6 | 22 | 6 | 18 | 115 |
| t _{PLH} | G or \overline{G} | Any Y | 2 | 22 | 3 | 17 | ns |
| t _{PHL} | 9 01 9 | Ally I | 4 | 21 | 4 | 17 | 115 |

[¶] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage, V _{CC} | 7 \ |
|--|----------------|
| Input voltage, V _I | 7 \ |
| Operating free-air temperature range, T _A : SN54AS138 | -55°C to 125°C |
| SN74AS138 | 0°C to 70°C |
| Storage temperature range, T _{stq} | -65°C to 150°C |

recommended operating conditions

| | | SN54AS138 | | SN74AS138 | | | UNIT | |
|-----------------|--------------------------------|-----------|-----|-----------|-----|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| V _{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| ІОН | High-level output current | | | -2 | | | -2 | mA |
| loL | Low-level output current | | | 20 | | | 20 | mA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | TEST C | SI | N54AS13 | 88 | SI | N74AS13 | 8 | UNIT | |
|------------------|---|--------------------------|--------------------|------------------|------|--------------------|------------------|------|------|
| PARAMETER | TEST CONDITIONS | | | TYP [‡] | MAX | MIN | TYP [‡] | MAX | UNIT |
| VIK | V _{CC} = 4.5 V, | $I_{I} = -18 \text{ mA}$ | | | -1.2 | | | -1.2 | V |
| Voн | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ | $I_{OH} = -2 \text{ mA}$ | V _{CC} -2 | 2 | | V _{CC} -2 | 2 | | V |
| V _{OL} | $V_{CC} = 4.5 \text{ V},$ | $I_{OL} = 20 \text{ mA}$ | | 0.35 | 0.5 | | 0.35 | 0.5 | V |
| lį | $V_{CC} = 5.5 \text{ V},$ | V _I = 7 V | | | 0.1 | | | 0.1 | mA |
| l _{IH} | $V_{CC} = 5.5 \text{ V},$ | V _I = 2.7 V | | | 20 | | | 20 | μΑ |
| I _Ι L | $V_{CC} = 5.5 \text{ V},$ | V _I = 0.4 V | | | -0.5 | | | -0.5 | mA |
| IO§ | V _{CC} = 5.5 V, | V _O = 2.25 V | -30 | | -112 | -30 | | -112 | mA |
| Іссн | V _{CC} = 5.5 V | | | 12 | 17.5 | | 12 | 17.5 | mA |
| ICCL | V _{CC} = 5.5 V | | | 14 | 20 | | 14 | 20 | mA |

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

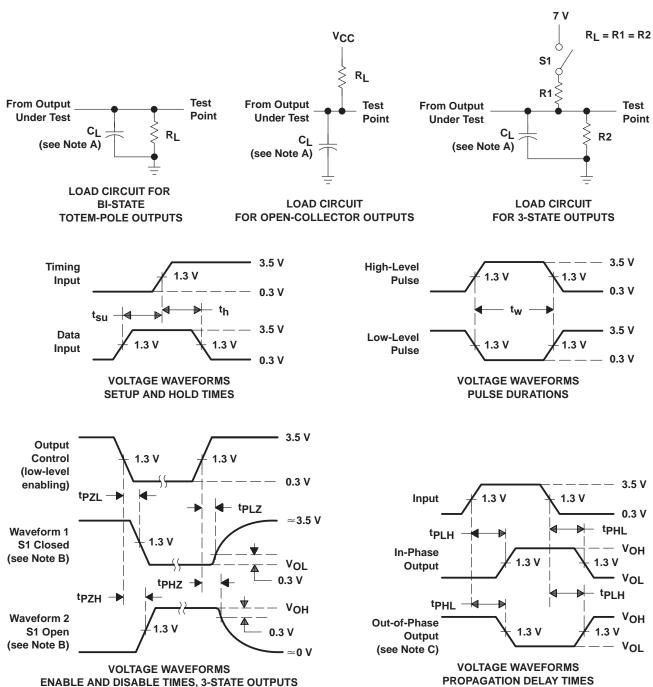
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switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _C C _L R _L T _A | UNIT | | | |
|------------------|-----------------|----------------|--|------|-------|------|-----|
| | , , | , , | SN54AS138 | | SN74A | S138 | |
| | | | MIN | MAX | MIN | MAX | |
| t _{PLH} | A, B, C | Any Y | 2 | 11 | 2 | 10 | ns |
| t _{PHL} | А, Б, С | Ally I | 2 | 11 | 2 | 9.5 | 113 |
| t _{PLH} | G1 | Any V | 2 | 11.5 | 2 | 10 | ns |
| ^t PHL | 9 | Any Y | 2 | 11 | 2 | 10 | 115 |
| t _{PLH} | G 2 | Any V | 2 | 9 | 2 | 7.5 | no |
| ^t PHL | G2 | Any Y | 2 | 10 | 2 | 8.5 | ns |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







26-Sep-2005

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 5962-86866012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| 5962-8686601FA | ACTIVE | CFP | W | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/37701B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/37701BEA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54ALS138AJ | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN54AS138J | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SN74ALS138AD | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ALS138ADG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ALS138ADR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ALS138ADRG4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ALS138AN | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74ALS138ANE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74ALS138ANSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ALS138ANSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS138D | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS138DE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS138DR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS138DRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS138N | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74AS138N3 | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI |
| SN74AS138NE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74AS138NSR | ACTIVE | so | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS138NSRE4 | ACTIVE | so | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SNJ54ALS138AFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54ALS138AJ | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54ALS138AW | ACTIVE | CFP | W | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54AS138FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Level-NC-NC-NC |
| SNJ54AS138J | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.



PACKAGE OPTION ADDENDUM

26-Sep-2005

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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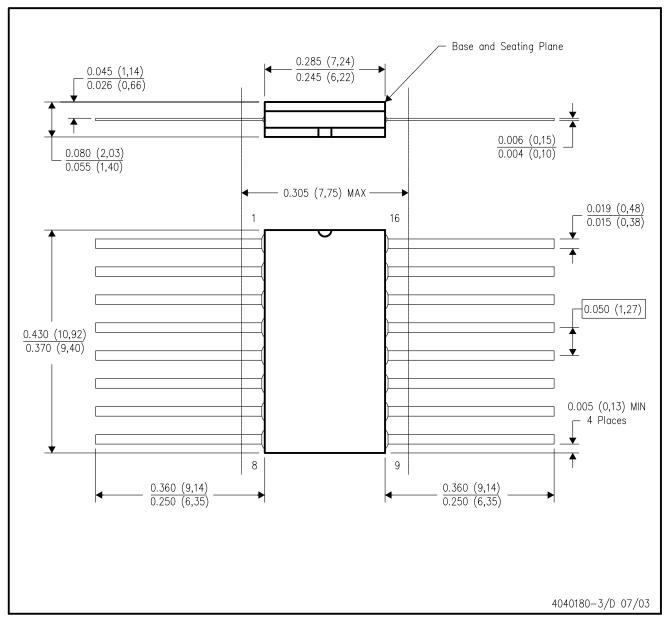
14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

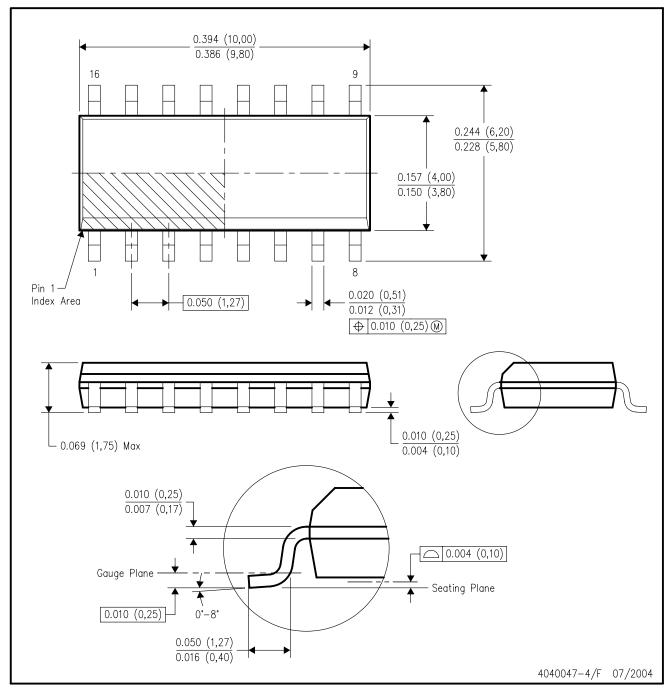


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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